2.0x1.25mm SMD CHIP LED LAMP

Part Number: APT2012VGC/A Green



ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

Features

- 2.0mmx1.25mm SMT LED,0.75mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE: 2000PCS/REEL.
- MOISTURE SENSITIVITY LEVEL: LEVEL 3.
- RoHS COMPLIANT.

Description

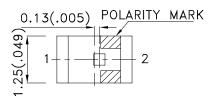
The Green source color devices are made with InGaN on G-SiC Light Emitting Diode.

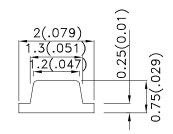
Static electricity and surge damage the LEDS.

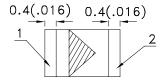
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

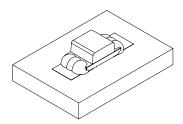
Package Dimensions











- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1 (0.004")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.4. The device has a single mounting surface. The device must be mounted according to the specifications.





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Selection Guide

| Part No. | Dice | Dice Lens Type | | lv (mcd) [2] @ 20mA | |
|--------------|---------------|----------------|------|------------------------|-------|
| | | | Min. | Тур. | 201/2 |
| APT2012VGC/A | Green (InGaN) | WATER CLEAR | 50 | 180 | 120° |

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Device | Тур. | Max. | Units | Test Conditions |
|--------|--------------------------|--------|------|------|-------|--------------------|
| λpeak | Peak Wavelength | Green | 520 | | nm | I=20mA |
| λD [1] | Dominant Wavelength | Green | 525 | | nm | IF=20mA |
| Δλ1/2 | Spectral Line Half-width | Green | 35 | | nm | IF=20mA |
| С | Capacitance | Green | 100 | | pF | VF=0V;f=1MHz |
| VF [2] | Forward Voltage | Green | 3.2 | 4 | V | IF=20mA |
| lr | Reverse Current | Green | | 10 | uA | V _R =5V |

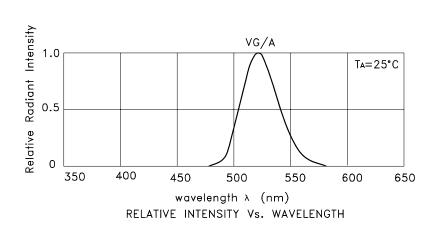
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

| A solution maximum reasings at 171 20 0 | | | | |
|---|----------------|----|--|--|
| Parameter | Green | | | |
| Power dissipation | 120 | mW | | |
| DC Forward Current | 30 | mA | | |
| Peak Forward Current [1] | 100 | mA | | |
| Reverse Voltage | 5 | V | | |
| Operating Temperature | -40°C To +85°C | | | |
| Storage Temperature | -40°C To +85°C | | | |
| | | | | |

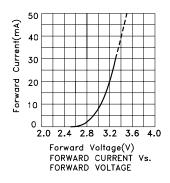
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

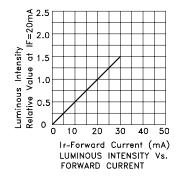
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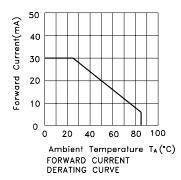


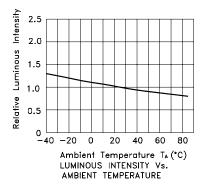
Green

APT2012VGC/A



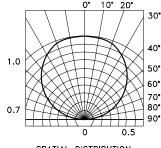






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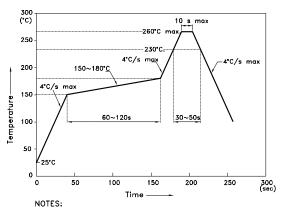


SPATIAL DISTRIBUTION

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APT2012VGC/A

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

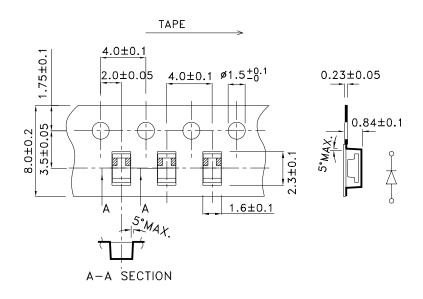
 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Specifications

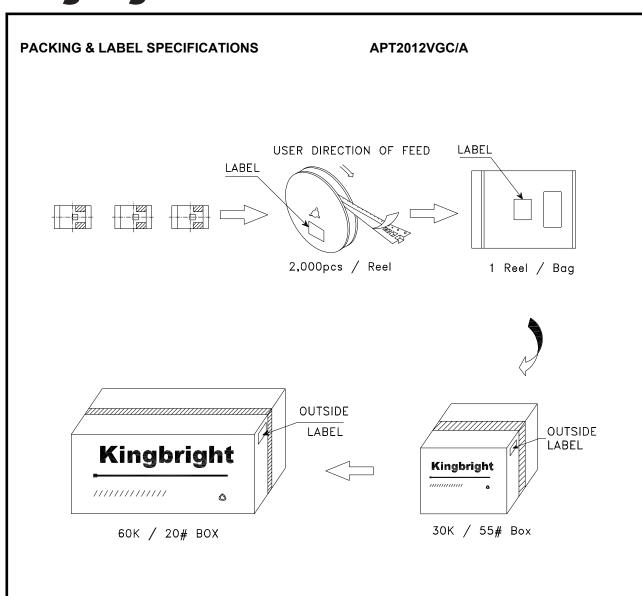
(Units: mm)



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